	Туре	Hits	Search Text	DBs
1	BRS	879	715/530	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
2	BRS	314	"structured part"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
3	BRS	28	"structured part" and list	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
4	BRS	7225	simulation and parts and list	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
5	BRS	292	simulation and parts and list and manufacture and price and size and shape	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
6	BRS	252	simulation and parts and list and semiconductor and size and price	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
7	BRS	9936	"parts list"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
8	BRS	2632	"parts list" and circuit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
9	BRS	195	"parts list" and circuit and price	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
10	BRS	4954	705/26	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
11	BRS	46	"parts list" and simulation and price	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
12	BRS	1651	716/1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
13	BRS	287	703/20	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
14	BRS	1	"compatibility prediction" and simulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
15	BRS	5	"compatibility prediction"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
16	BRS	6886	prediction and part and simulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
17	BRS	60	prediction and "parts list" and simulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

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18	BRS	2	"20010014836"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
19	BRS	2	6110213.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB